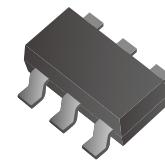


CEH2315-HF

P-Channel
RoHS Device
Halogen Free



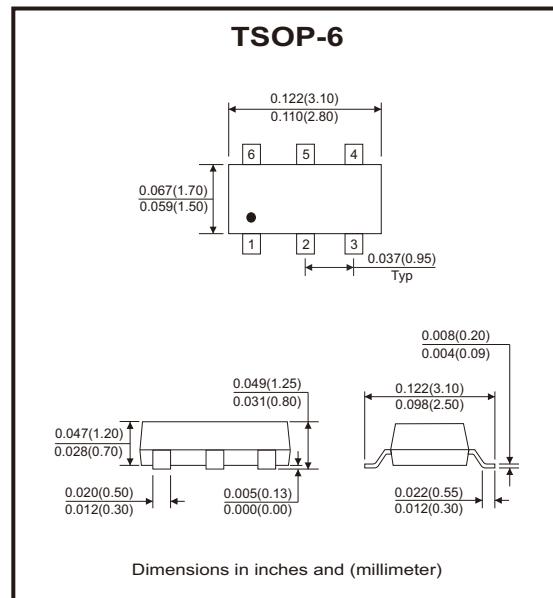
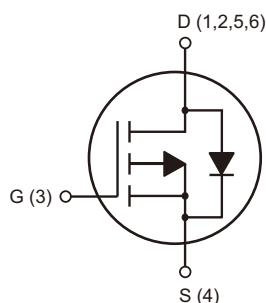
Features

- High density cell design for extremely low R_{DSON}.
- Rugged and reliable.

Mechanical data

- Case : TSOP-6, molded plastic.
- Mounting position: Any.

Circuit Diagram



Maximum Ratings (at Ta=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-source voltage	V _{DS}	-30	V
Gate-source voltage	V _{GS}	±20	V
Drain current-continuous	I _D	-5	A
Drain current-pulsed (Note 1)	I _{DM}	-20	A
Maximum power dissipation	P _D	2	W
Thermal resistance, Junction to ambient (Note 2)	R _{θJA}	62.5	°C/W
Operating and storage temperature range	T _J , T _{STG}	-55 to +150	°C

Notes: 1. Repetitive rating: pulse width limited by maximum junction temperature.

2. Surface mounted on FR4 board, t < 5 sec.

Electrical Characteristics (at $T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Off characteristics						
Drain-source breakdown voltage	BV_{DSS}	$V_{\text{GS}} = 0\text{V}, I_{\text{D}} = -250\mu\text{A}$	-30			V
Zero gate voltage drain current	I_{DS}^0	$V_{\text{DS}} = -30\text{V}, V_{\text{GS}} = 0\text{V}$			-1	μA
Gate body leakage current, forward	I_{GSSF}	$V_{\text{GS}} = 20\text{V}, V_{\text{DS}} = 0\text{V}$			100	nA
Gate body leakage current, reverse	I_{GSSR}	$V_{\text{GS}} = -20\text{V}, V_{\text{DS}} = 0\text{V}$			-100	nA
On characteristics (Note 1)						
Gate threshold voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{GS}} = V_{\text{DS}}, I_{\text{D}} = -250\mu\text{A}$	-1		-3	V
Static drain-source on-resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = -10\text{V}, I_{\text{D}} = -3.8\text{A}$		40	50	$\text{m}\Omega$
		$V_{\text{GS}} = -4.5\text{V}, I_{\text{D}} = -3\text{A}$		60	85	
Dynamic characteristics (Note 2)						
Input capacitance	C_{iss}	$V_{\text{DS}} = -15\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		650		pF
Output capacitance	C_{oss}			130		
Reverse transfer capacitance	C_{rss}			75		
Switching characteristics (Note 2)						
Turn-on delay time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = -15\text{V}, I_{\text{D}} = -1\text{A}, V_{\text{GS}} = -10\text{V}, R_{\text{GEN}} = 6\Omega$		10		nS
Turn-on rise time	t_r			4		
Turn-off delay time	$t_{\text{d}(\text{off})}$			36		
Turn-off fall time	t_f			6		
Total gate charge	Q_g	$V_{\text{DS}} = -15\text{V}, I_{\text{D}} = -3.6\text{A}, V_{\text{GS}} = -10\text{V}$		11.2		nC
Gate-source charge	Q_{gs}			1.7		
Gate-drain charge	Q_{gd}			2.0		
Drain-source diode characteristics and maximum ratings						
Drain-source diode forward current (Note 3)	I_s				-1.6	A
Drain-source diode forward voltage (Note 1)	V_{SD}	$V_{\text{GS}} = 0\text{V}, I_s = -1.6\text{A}$			-1.2	V

- Notes:
1. Pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.
 2. Guaranteed by design, not subject to production testing.
 3. Surface mounted on FR4 board, $t < 5 \text{ sec.}$

Rating and Characteristic Curves (CEH2315-HF)

Fig.1 - Output Characteristics

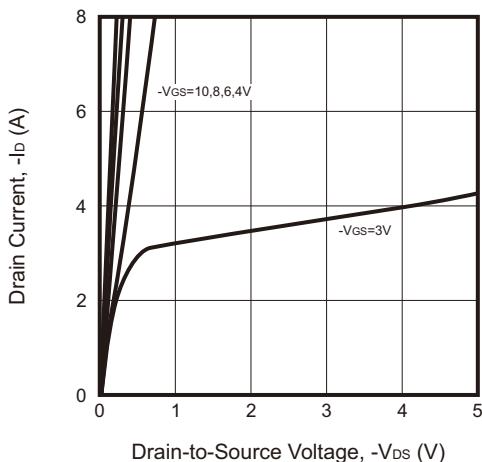


Fig.2 - Transfer Characteristics

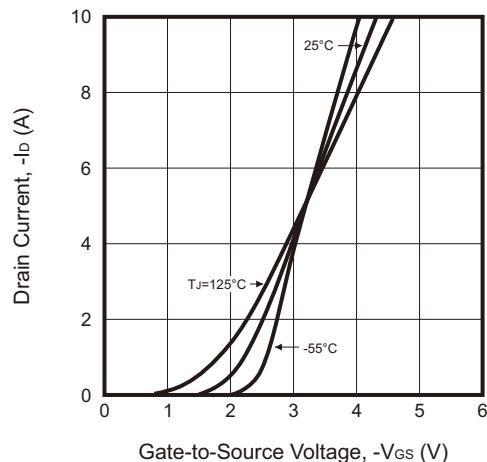


Fig.3 - Capacitance

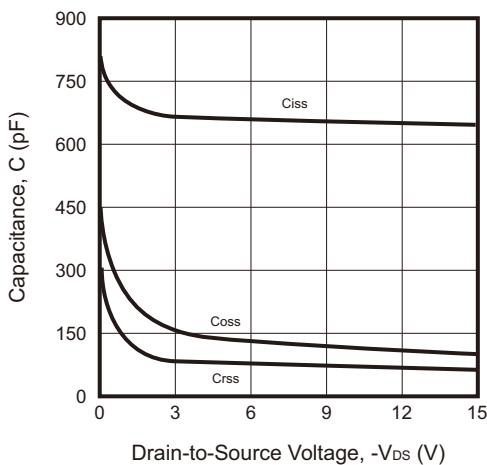


Fig.4 - On-Resistance Variation With Temperature

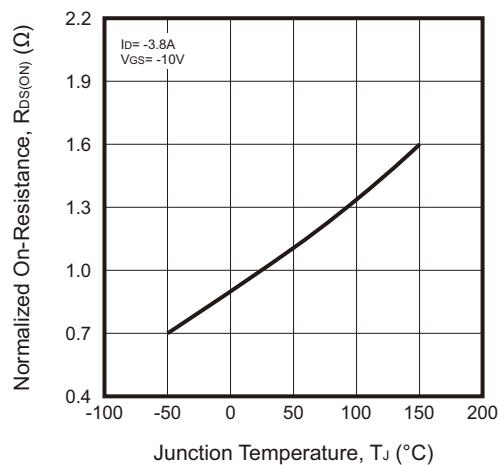


Fig.5 - Gate Threshold Variation With Temperature

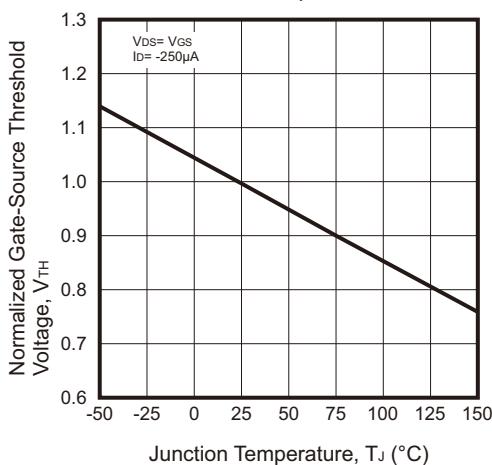
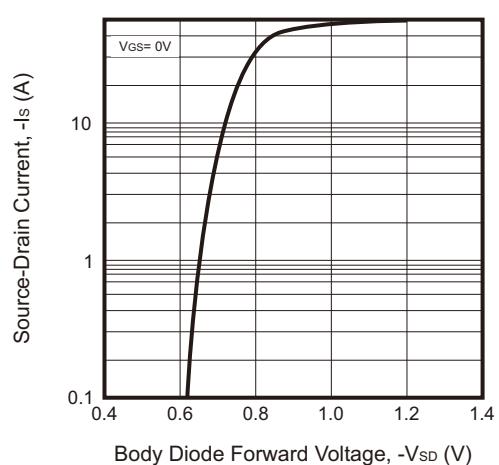


Fig.6 - Body Diode Forward Voltage Variation With Source Current



Rating and Characteristic Curves (CEH2315-HF)

Fig.7 - Gate Charge

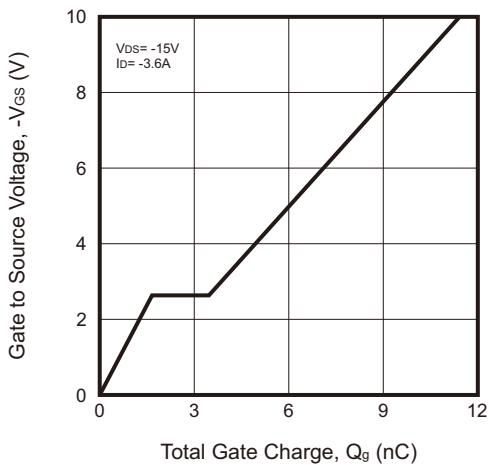


Fig.8 - Max. Safe Operating Area

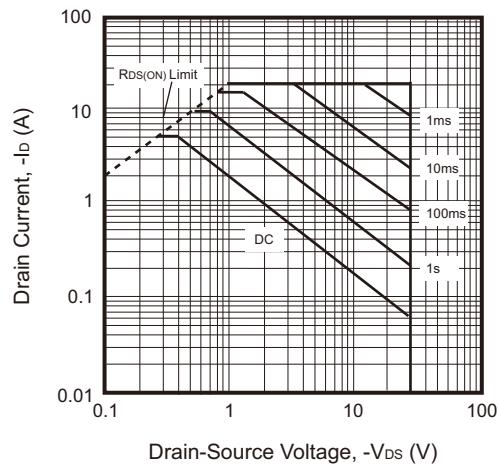
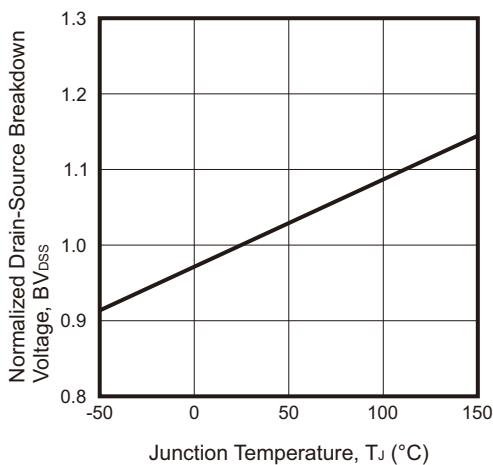
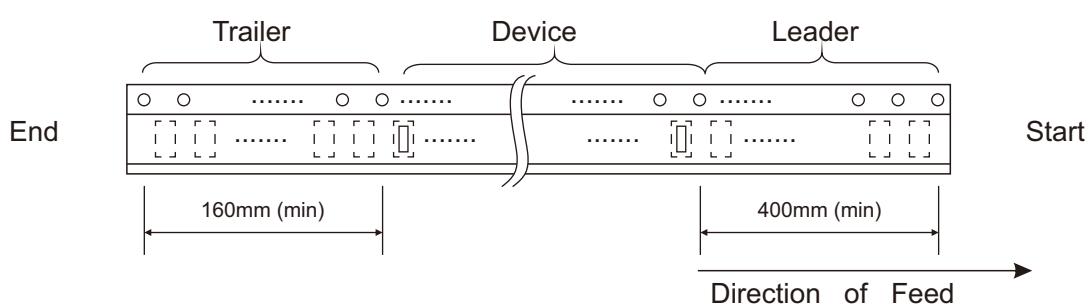
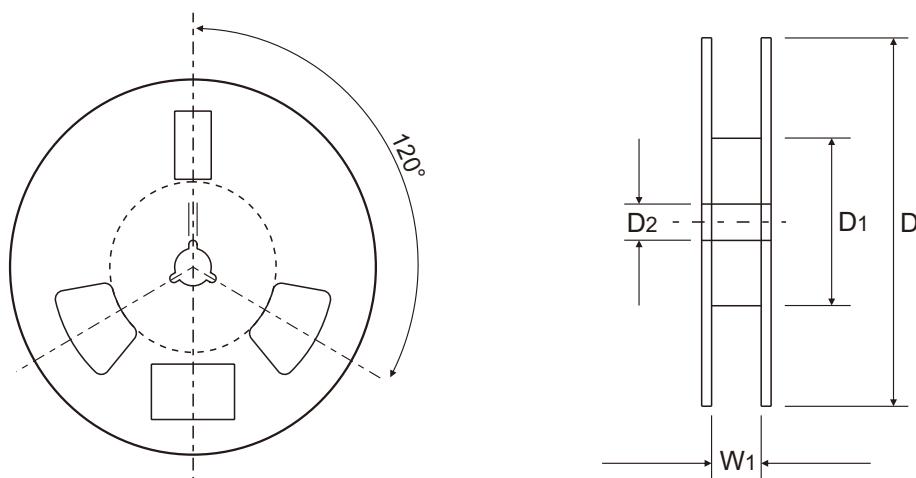
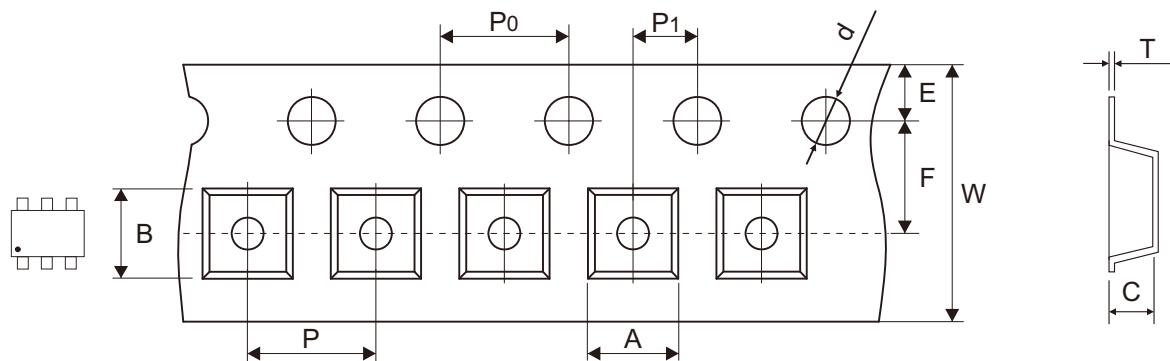


Fig.9 - Breakdown Voltage Variation vs Temperature



Reel Taping Specification

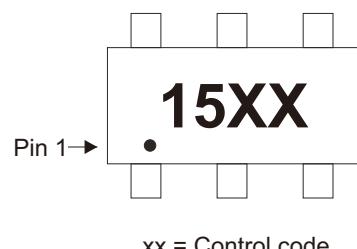


TSOP-6	SYMBOL	A	B	C	d	D	D1	D2
	(mm)	3.20 ± 0.10	3.05 ± 0.10	1.20 ± 0.10	$1.50 + 0.10 - 0.00$	178 ± 1.00	54.00 ± 0.50	13.50 ± 0.20
	(inch)	0.126 ± 0.004	0.120 ± 0.004	0.047 ± 0.004	$0.059 + 0.004 - 0.000$	7.008 ± 0.039	2.126 ± 0.020	0.531 ± 0.008

TSOP-6	SYMBOL	E	F	P	P0	P1	T	W	W1
	(mm)	1.75 ± 0.10	3.50 ± 0.05	4.00 ± 0.10	4.00 ± 0.10	2.00 ± 0.05	0.25 ± 0.05	8.00 ± 0.15	9.50 ± 1.00
	(inch)	0.069 ± 0.004	0.138 ± 0.002	0.157 ± 0.004	0.157 ± 0.004	0.079 ± 0.002	0.010 ± 0.002	0.315 ± 0.006	0.374 ± 0.039

Marking Code

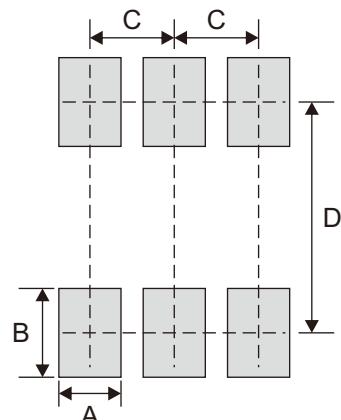
Part Number	Marking Code
CEH2315-HF	15



xx = Control code

Suggested P.C.B. PAD Layout

SIZE	TSOP-6	
	(mm)	(inch)
A	0.70 Min	0.028 Min
B	1.00 Min	0.039 Min
C	0.95	0.037
D	2.60	0.102



Standard Packaging

Case Type	REEL PACK	
	REEL (pcs)	Reel Size (inch)
TSOP-6	3,000	7